



RECOMMENDED P.C.B LAYOUT

NOTE:

1.MATERIAL:

HOUSING: LCP 30% G/F UL 94V-0 ;BLACK
COVER: LCP 30% G/F UL 94V-0 ;BLACK
CONTACT(1.27): C5191R-H,T=0.30±0.01mm
CONTACT(0.8): C5191R-H,T=0.25±0.01mm
PEG: C2680R-H,T=0.30±0.01mm

2.MECHANICAL:

MATING: 25N MAX.
WITHDRAWAL FORCE: 5N MIN.
DURABILITY: 500 CYCLES.

3.ELECTRICAL:

CURRENT RATING: 1.5 A
CONTACT RESISTANCE:30 Milliohms MAX.
INSULATION RESISTANCE: 1000 Megohms MIN.
WITHSTANDING VOLTAGE: 500 VAC

4.FINISH:

CONTACT: 1u" GOLD MIN. PLATING ON CONTACT AREA
100u"MIN. TIN PLATING ON SOLDER TAILS
50u" MIN. NICKEL UNDERPLATING OVER ALL
PEG:100u" MIN. TIN PLATING ON SOLDER AREA
50u" MIN.NICKEL UNDERPLATING OVER ALL

5.ENVIRONMENTAL:

OPERATURE RANGE:-25°C TO +85°C

2ST F 005 C 029 ** 05 1 4

包装方式: TUBE PACKAGE(管装)

颜色: BLACK (黑色)

电镀码: 半金雾锡G0 = FLASH ,

G2 = 3u, G3 = 5u,

G4 = 10u, G5 = 15u,

				.X ±0.30	.X° ±1.0°	东莞市文章济美电子有限公司		
				.XX ±0.25	.XX° ±0.5°			
				.XXX ±0.20	.XXX° ±0.2°			
1.1				SCALE 1:1	UNIT mm	Part Name: SAS 29PIN 母座180° DIP双排双柱2.2加倒角	Approved:	
REV:	ECN. NO	DR. BY	DATE	PAGE: 1/1	REV: 1.0	Part No.: 5001-2STF005C029G50514-B	Checked:	
						Title:	Material:	Drawn: TONY JIANG
						Drawing No.:	Mode NO.:	Date: 2012-10-30